

## Description

The AP7346 is a dual high accuracy current limit, low dropout regulator with high output voltage accuracy, low  $R_{DS(ON)}$ , high PSRR, low output noise and low quiescent current. This regulator is based on a CMOS process.

Each of regulators includes a voltage reference, error amplifier, current limit circuit and an enable input to turn on/ off output. With the integrated resistor network, fixed output voltage versions can be delivered.

With its low power consumption and line and load transient response, the AP7346 is well suited for low power handheld communication equipment.

The AP7346 is packaged in X2-DFN1212-6 package and allows for smallest footprint and dense PCB layout.

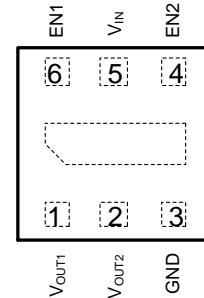
## Features

- Low  $V_{IN}$  and Wide  $V_{IN}$  Range: 1.7V to 5.25V
- High Accuracy Current Limit: 157mA +/- 25mA
- $V_{OUT}$  Accuracy:  $\pm 1\%$
- Ripple Rejection: 75dB at 1kHz
- Low Output Noise: 60 $\mu$ Vrms from 10Hz to 100kHz
- Quiescent Current as Low as 35 $\mu$ A
- $V_{OUT}$  Fixed 1.2V to 3.6V
- **Totally Lead-Free & and Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free, Green Device (Note 3)**

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Assignments

### Top View

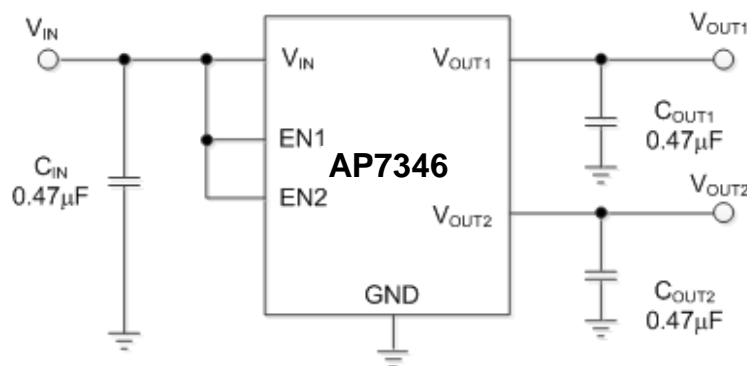


**X2-DFN1212-6**

## Applications

- Fingerprint Modular
- Smart Phone/PAD
- RF Supply
- Cameras
- Portable Video
- Portable Media Player
- Wireless Adapter
- Wireless Communication

## Typical Applications Circuit

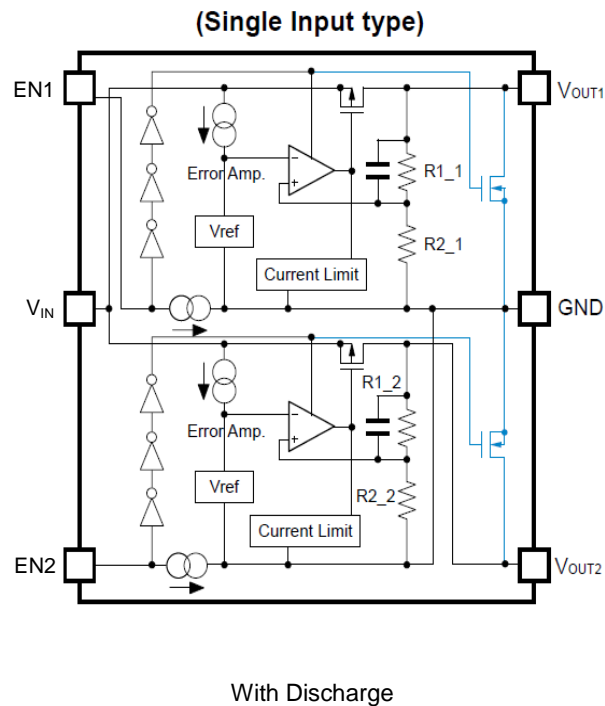


**Pin Descriptions**

Pin Number	Pin Name	Function
1	V <sub>OUT1</sub>	Channel 1 output voltage pin
2	V <sub>OUT2</sub>	Channel 2 output voltage pin
3	GND	Ground
4	EN2	Channel 2 enable pin. This pin should be driven either high or low and must not be floating. Driving this pin high enables channel 2 output, while pulling it low puts Channel 2 regulator into shutdown mode.
5	V <sub>IN</sub>	Power input pin
6	EN1	Channel 1 enable pin. This pin should be driven either high or low and must not be floating. Driving this pin high enables channel 1 output, while pulling it low puts Channel 1 regulator into shutdown mode.
-	Thermal PAD	In PCB layout, prefer to use large copper area to cover this pad for better thermal dissipation, then connect this area to GND or leave it open. However do not use it as GND electrode function alone.

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**Functional Block Diagram**



### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified. Note 4)

Symbol	Parameter	Rating	Unit
V <sub>IN</sub>	Input Voltage	6.0	V
V <sub>EN</sub>	Input Voltage at EN Pins	6.0	V
V <sub>OUT</sub>	Output Voltage	-0.3 to V <sub>IN</sub> +0.3	V
I <sub>OUT</sub>	Output Current	130	mA
P <sub>D</sub>	Power Dissipation	600	mW
T <sub>A</sub>	Operating Ambient Temperature	-40 to +85	°C
T <sub>STG</sub>	Storage Temperature	-55 to +125	°C

Note 4: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
V <sub>IN</sub>	Input Voltage	1.7	5.25	V
I <sub>OUT</sub>	Output Current	0	130	mA
T <sub>A</sub>	Operating Ambient Temperature	-40	+85	°C

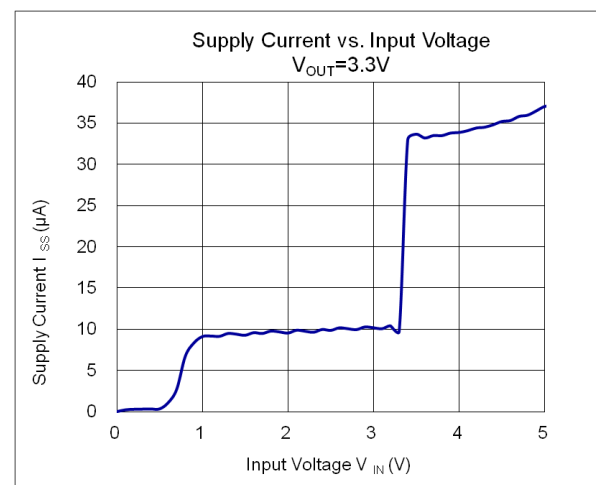
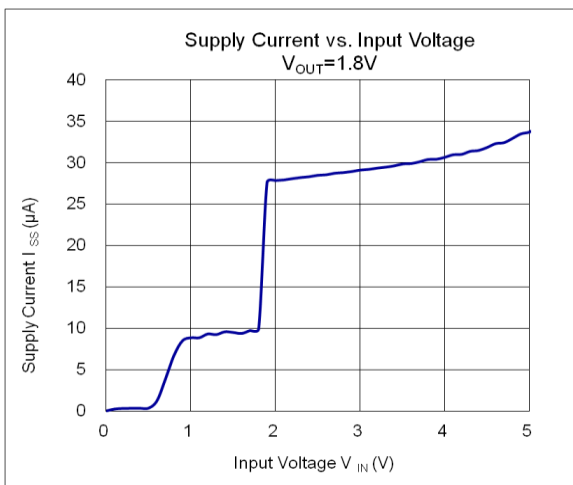
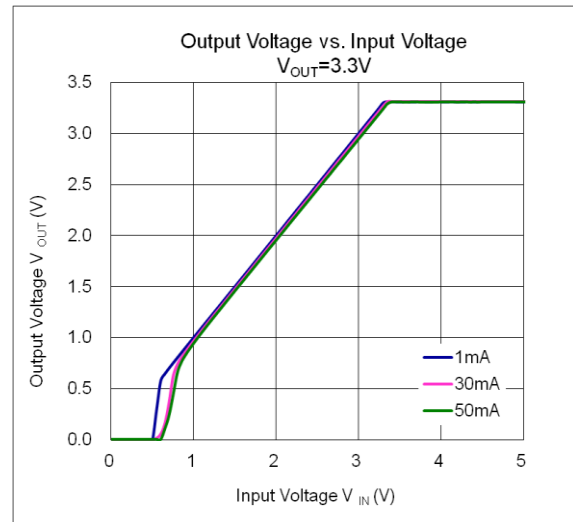
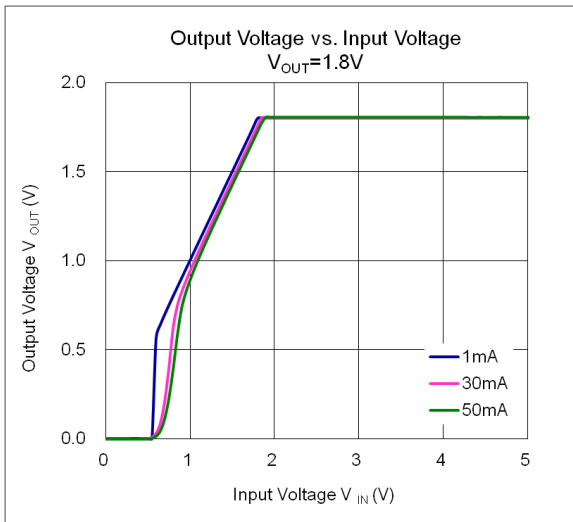
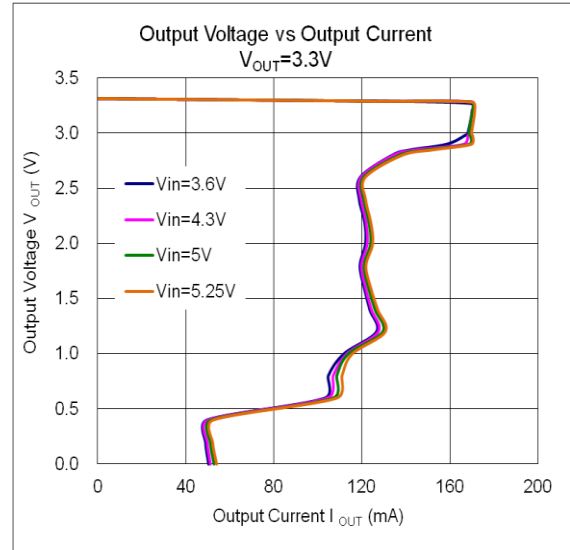
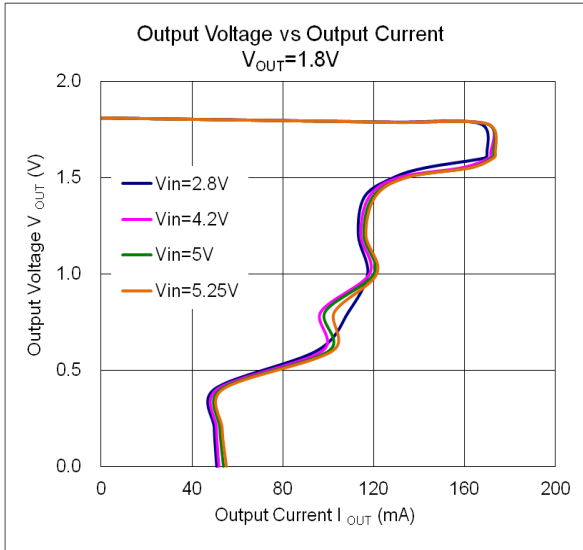
**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ ,  $V_{IN} = V_{OUT} + 1\text{V}$  ( $V_{OUT} > 1.5\text{V}$ ),  $V_{IN} = 2.5\text{V}$  ( $V_{OUT} \leq 1.5\text{V}$ ),  $I_{OUT} = 1\text{mA}$ ,  $C_{IN} = C_{OUT} = 1.0\mu\text{F}$ , unless otherwise specified.)

Parameter	Conditions	Min	Typ	Max	Unit	
Input Voltage	$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	1.7	–	5.25	V	
Output Voltage Accuracy (Note 11)	$V_{IN} = (V_{OUT-NOM} + 1.0\text{V})$ to $5.25\text{V}$ , $I_{OUT} = 1\text{mA}$ to $120\text{mA}$	$T_A = +25^\circ\text{C}$	-1	–	1	%
		$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	-1.5	–	1.5	
Line Regulation ( $\Delta V_{OUT}/\Delta V_{IN}/V_{OUT}$ )	$V_{IN} = (V_{OUT-NOM} + 1.0\text{V})$ to $5.25\text{V}$ , $I_{OUT} = 1.0\text{mA}$	–	0.02	0.1	%/V	
Load Regulation ( $\Delta V_{OUT}/\Delta I_{OUT}$ )	$V_{IN} = V_{OUT-NOM} + 1.0\text{V}$ , $I_{OUT} = 1\text{mA}$ to $120\text{mA}$	–	15	30	mV	
Quiescent Current (Note 6)	Set EN1 high, set EN2 low, or set EN2 high, set EN1 low, No load	–	35	50	$\mu\text{A}$	
	Set EN1/EN2 high, No load	–	70	100	$\mu\text{A}$	
$I_{STANDBY}$	Set EN1/EN2 low, No load	–	0.1	1.0	$\mu\text{A}$	
Output Current	–	130	–	–	mA	
Fold-back Short Current (Note 7)	$V_{OUT}$ short to ground	–	55	–	mA	
PSRR (Note 8)	$V_{IN} = (V_{OUT} + 1\text{V}) V_{DC} + 0.2\text{Vp-pAC}$ , $V_{OUT} \geq 1.8\text{V}$ , $I_{OUT} = 30\text{mA}$	$f = 1\text{kHz}$	–	75	–	dB
Output Noise Voltage (Notes 8 & 9)	$BW = 10\text{Hz}$ to $100\text{kHz}$ , $I_{OUT} = 30\text{mA}$	–	60	–	$\mu\text{Vrms}$	
Dropout Voltage (Note 5)	$I_{OUT} = 120\text{mA}$	$V_{OUT} \leq 1.2\text{V}$	–	0.48	0.59	V
		$1.2\text{V} < V_{OUT} \leq 1.4\text{V}$	–	0.39	0.50	
		$1.4\text{V} < V_{OUT} \leq 1.7\text{V}$	–	0.35	0.44	
		$1.7\text{V} < V_{OUT} \leq 2.1\text{V}$	–	0.30	0.39	
		$2.1\text{V} < V_{OUT} \leq 2.5\text{V}$	–	0.26	0.34	
		$2.5\text{V} < V_{OUT} \leq 3.0\text{V}$	–	0.25	0.30	
		$3.0\text{V} < V_{OUT} \leq 3.6\text{V}$	–	0.22	0.29	
Output Voltage Temperature Coefficient	$I_{OUT} = 30\text{mA}$ , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	–	$\pm 30$	–	ppm/ $^\circ\text{C}$	
EN Input Low Voltage	–	0	–	0.5	V	
EN Input High Voltage	–	1.3	–	5.25	V	
EN Input Leakage	$V_{EN} = 0\text{V}$ , $V_{IN} = 5.0\text{V}$ or $V_{EN} = 5.0\text{V}$ , $V_{IN} = 0\text{V}$	-1.0	–	1.0	$\mu\text{A}$	
OCP	–	132	157	182	mA	
On Resistance of N-channel for Auto-discharge (Note 10)	$V_{IN} = 4.0\text{V}$ , $V_{EN} = 0\text{V}$ (Disabled)	D Version Channels 1 & 2	–	50	–	$\Omega$

- Notes:
- Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
  - Quiescent current defined here is the difference in current between the input and the output.
  - Short circuit current is measured with  $V_{OUT}$  pulled to GND.
  - This specification is guaranteed by design.
  - To make sure lowest environment noise minimizes the influence on noise measurement.
  - AP7346 is available for built-in discharge.
  - Potential multiple grades based on following output voltage accuracy.

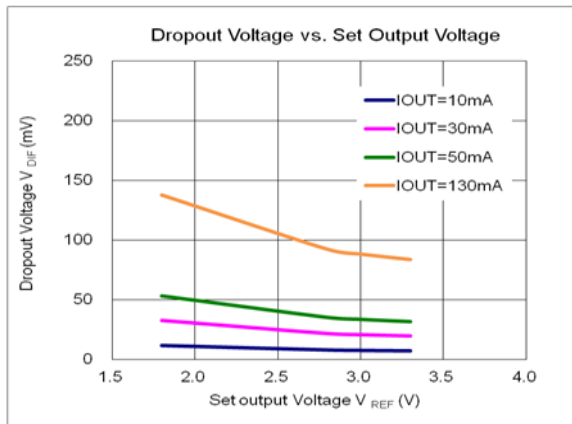
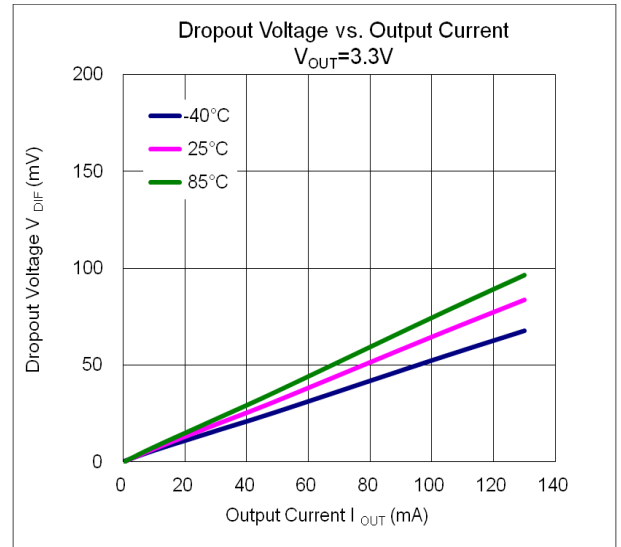
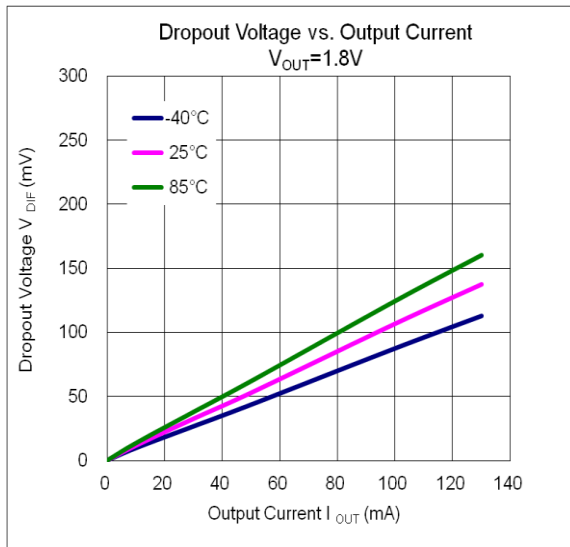
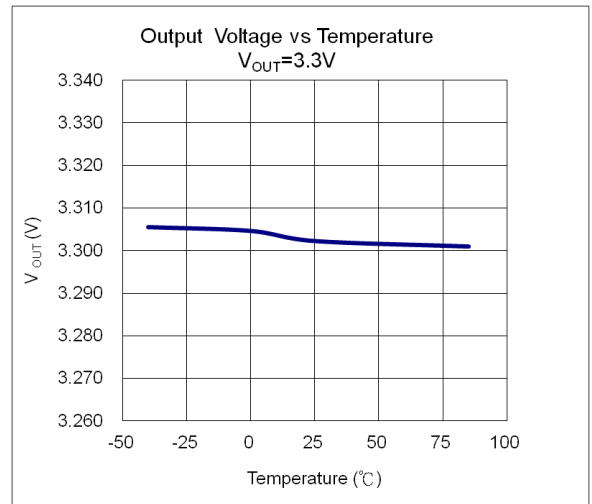
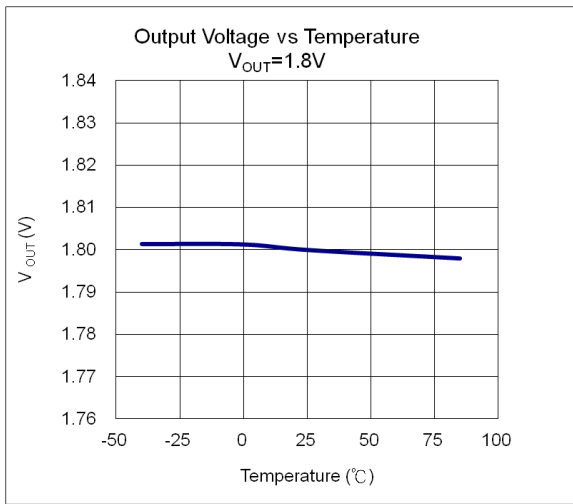
**Performance Characteristics**

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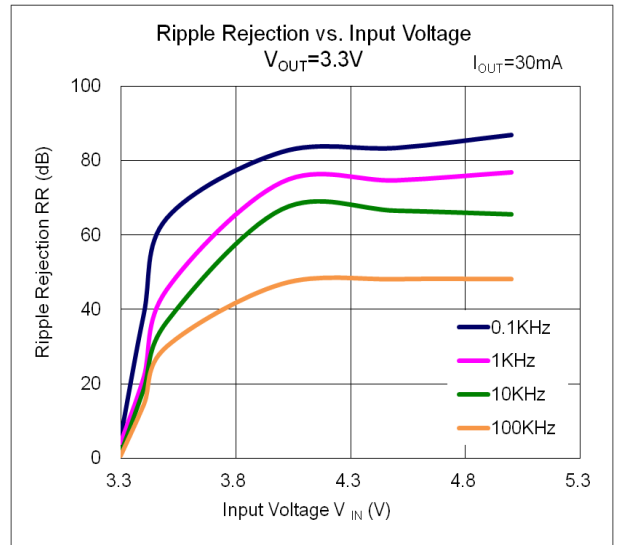
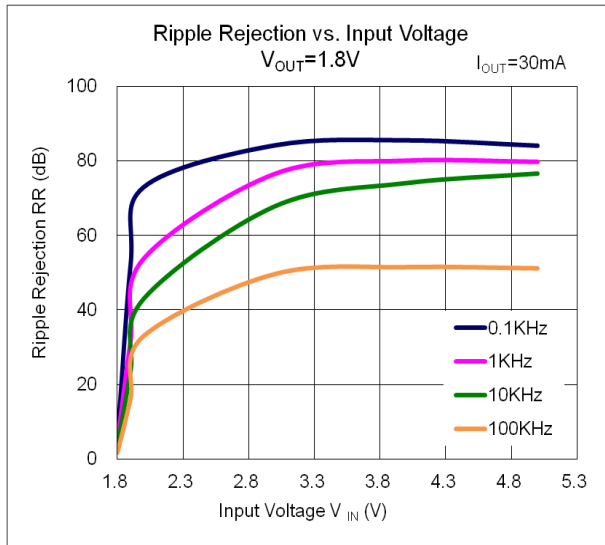
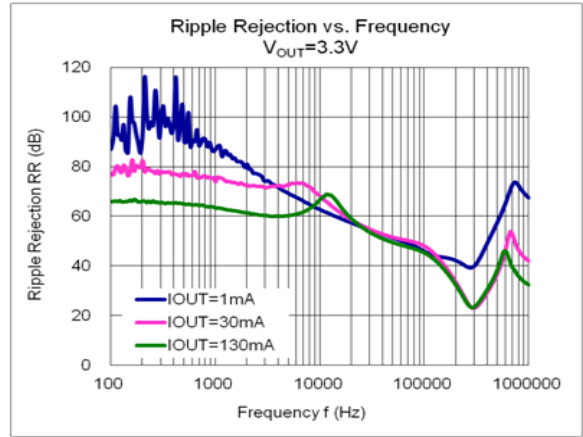
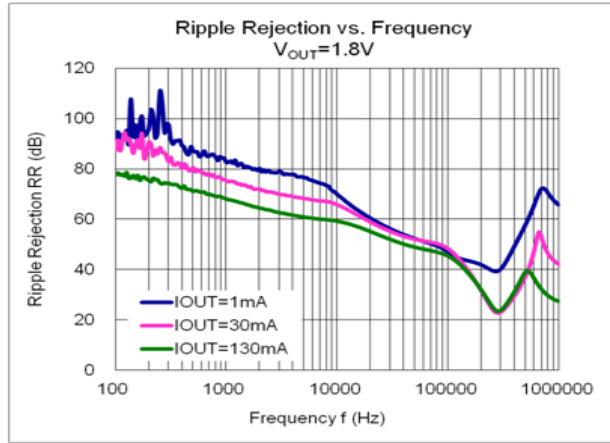


**Performance Characteristics (Cont.)**

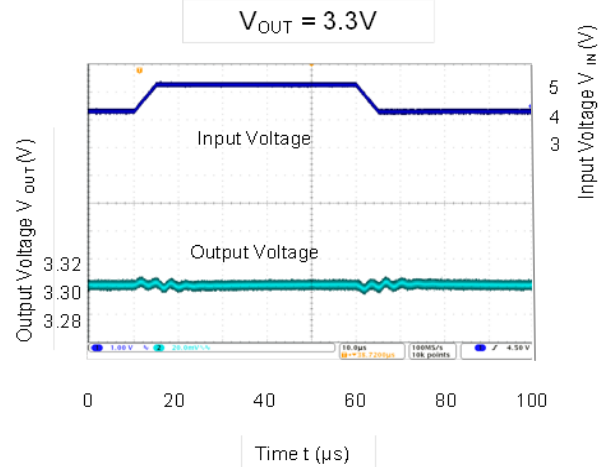
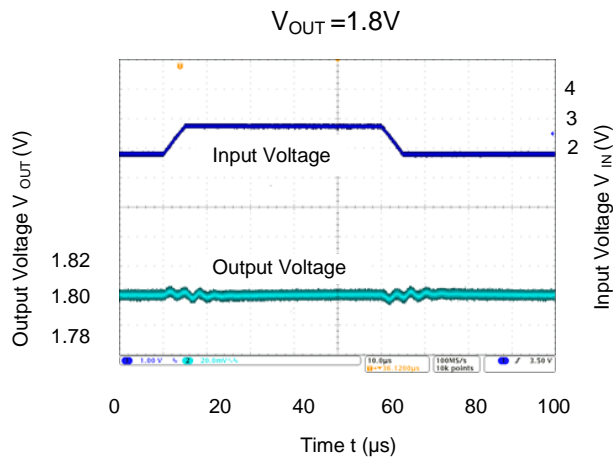
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**Performance Characteristics (Cont.)**

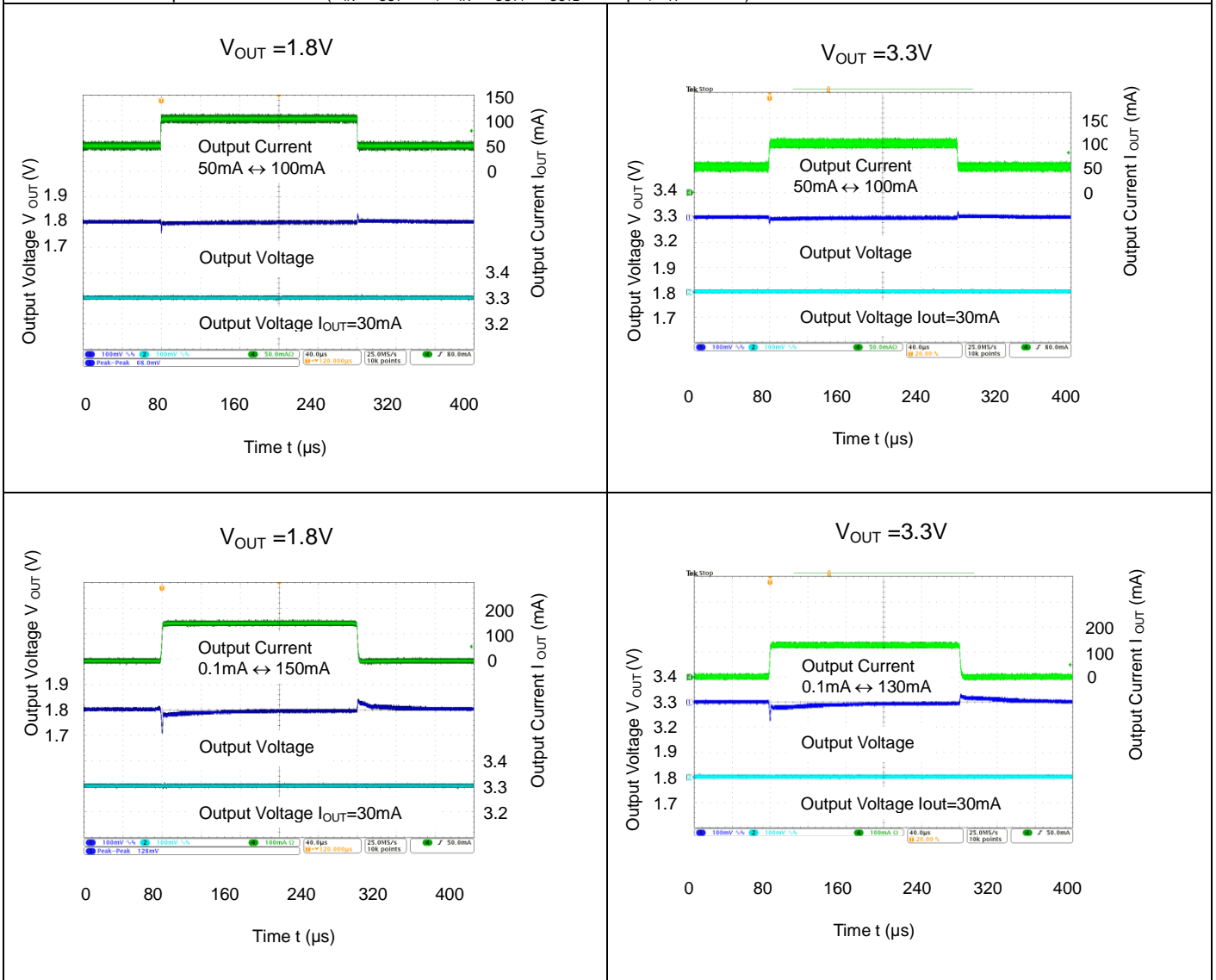


Line Transient Response Waveforms ( $I_{OUT}=30mA$ ,  $t_R=t_F=5\mu s$ ,  $C_{IN}=none$ ,  $C_{OUT1}=C_{OUT2}=0.47\mu F$ ,  $T_A=+25^\circ C$ )



**Performance Characteristics (Cont.)**

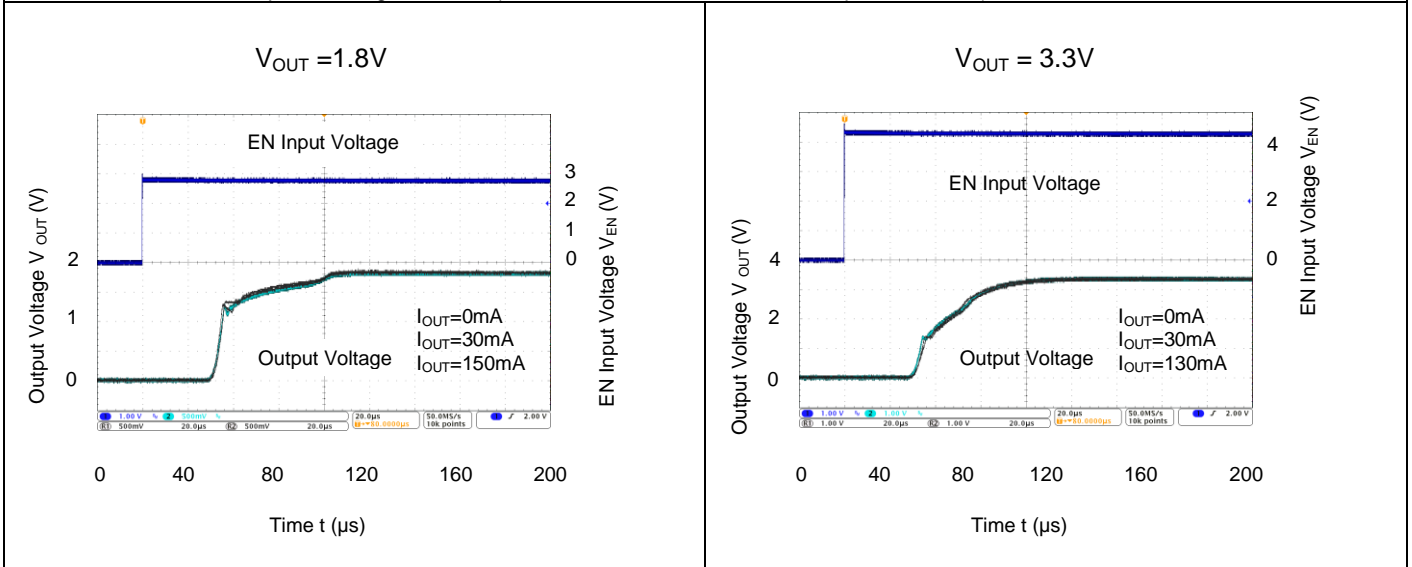
Load Transient Response Waveforms ( $V_{IN}=V_{OUT}+1V$ ,  $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$ ,  $T_A=+25^\circ C$ )



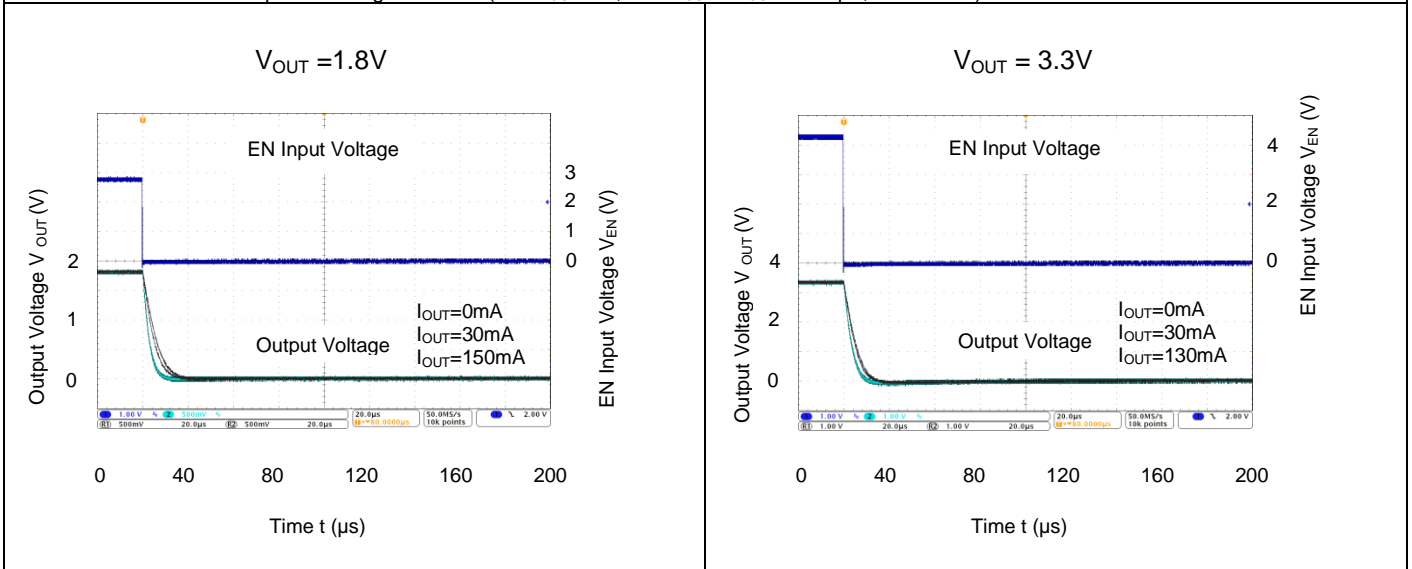
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**Performance Characteristics (Cont.)**

Turn On Waveform of Output Discharge Versions ( $V_{IN}=V_{OUT}+1V$ ,  $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$ ,  $T_A=+25^\circ C$ )



Turn Off Waveform of Output Discharge versions ( $V_{IN}=V_{OUT}+1V$ ,  $C_{IN}=C_{OUT1}=C_{OUT2}=0.47\mu F$ ,  $T_A=+25^\circ C$ )



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## Application Information

### Output Capacitor

An output capacitor ( $C_{OUT}$ ) is needed to improve transient response and maintain stability. The AP7346 is stable with very small ceramic output capacitors. The ESR (Equivalent Series Resistance) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin and care should be taken to reduce the impedance in the layout.

### Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor ( $C_{IN}$ ). A minimum  $0.47\mu\text{F}$  ceramic capacitor is recommended between  $V_{IN}$  and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both  $V_{IN}$  and GND pin.

### Enable Control

The AP7346 is turned on by setting the EN pins high, and is turned off by pulling it low. If this feature is not used, the EN pins should be tied to  $V_{IN}$  pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pins must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section.

### Short Circuit Protection

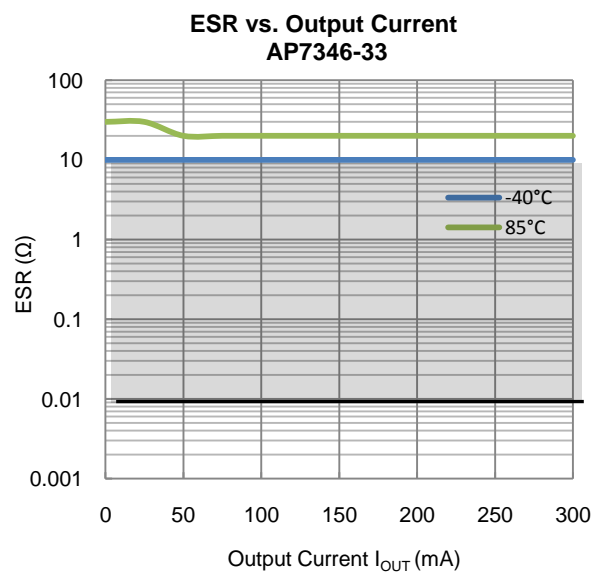
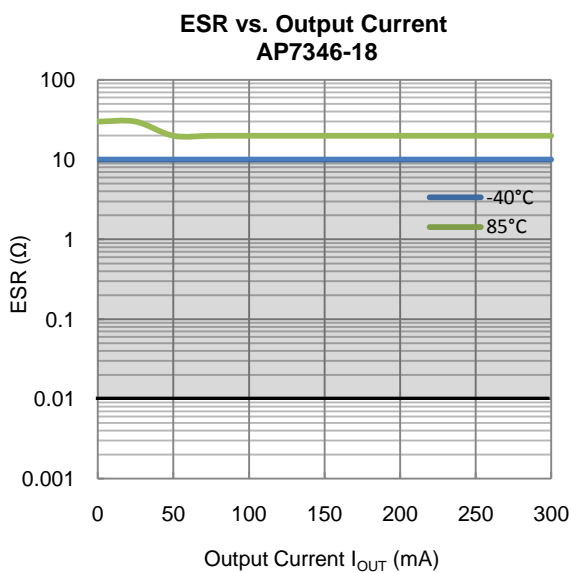
When  $V_{OUT}$  pins are short-circuit to GND, short circuit protection will be triggered and clamp the output current to approximately 60mA. This feature protects the regulator from over-current and damage due to overheating.

### Layout Considerations

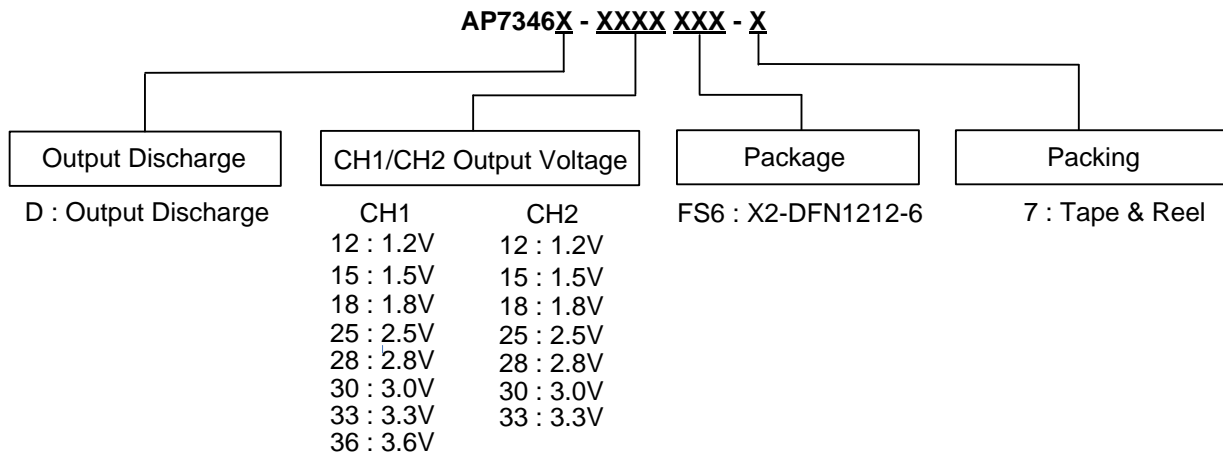
For good ground loop and stability, the input and output capacitors should be located close to the input, output, and GND pin of the device. The regulator GND pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from  $V_{IN}$  to  $V_{OUT}$ , and load circuit.

## ESR vs. Output Current

Ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between  $I_{OUT}$  (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph. Measurement conditions: Frequency Band: 10Hz to 2MHz, Temperature:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .



## Ordering Information

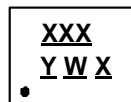


Device	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
AP7346D-XXXXFS6-7	FS6	X2-DFN1212-6	5000/Tape & Reel	-7

## Marking Information

(1) X2-DFN1212-6

(Top View)



XXX : Identification Code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;

a~z : 27~52 week; z represents 52 and 53 week

X : Internal code

Part Number	V <sub>OUT1</sub> /V <sub>OUT2</sub>	Package	Identification Code
AP7346D-1218FS6-7	1.2V/1.8V	X2-DFN1212-6	EAA
AP7346D-1528FS6-7	1.5V/2.8V	X2-DFN1212-6	EAB
AP7346D-1815FS6-7	1.8V/1.5V	X2-DFN1212-6	EAC
AP7346D-1818FS6-7	1.8V/1.8V	X2-DFN1212-6	EAD
AP7346D-1828FS6-7	1.8V/2.8V	X2-DFN1212-6	EAE
AP7346D-1833FS6-7	1.8V/3.3V	X2-DFN1212-6	EAF
AP7346D-2518FS6-7	2.5V/1.8V	X2-DFN1212-6	EAG

**Marking Information** (Cont.)

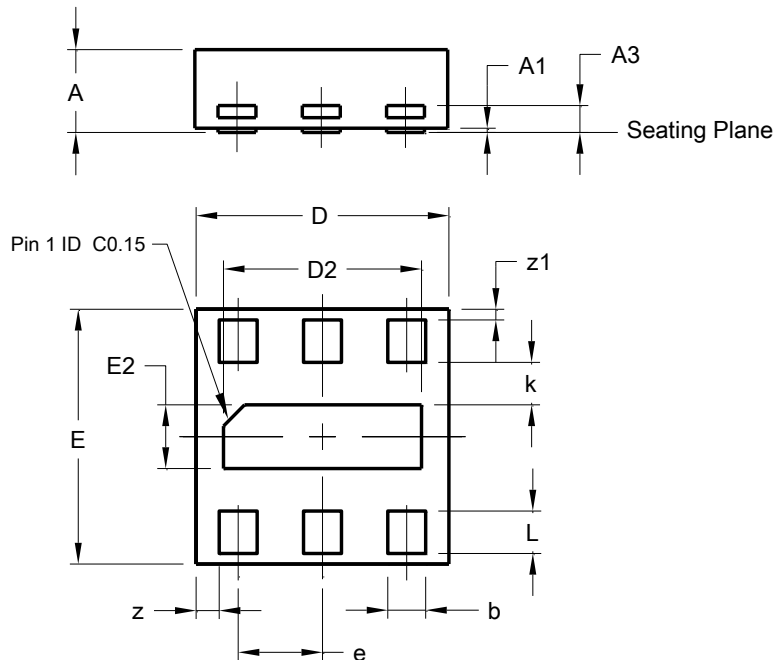
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AP7346D-2818FS6-7	2.8V/1.8V	X2-DFN1212-6	EAJ
AP7346D-2825FS6-7	2.8V/2.5V	X2-DFN1212-6	EAK
AP7346D-2833FS6-7	2.8V/3.3V	X2-DFN1212-6	EAM
AP7346D-3018FS6-7	3.0V/1.8V	X2-DFN1212-6	EAN
AP7346D-3028FS6-7	3.0V/2.8V	X2-DFN1212-6	EAP
AP7346D-3030FS6-7	3.0V/3.0V	X2-DFN1212-6	EAR
AP7346D-3318FS6-7	3.3V/1.8V	X2-DFN1212-6	EAS
AP7346D-3328FS6-7	3.3V/2.8V	X2-DFN1212-6	EAT
AP7346D-3330FS6-7	3.3V/3.0V	X2-DFN1212-6	EAU
AP7346D-3333FS6-7	3.3V/3.3V	X2-DFN1212-6	EAV
AP7346D-3612FS6-7	3.6V/1.2V	X2-DFN1212-6	EAW

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**Package Outline Dimensions** (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

(1) Package Type: X2-DFN1212-6

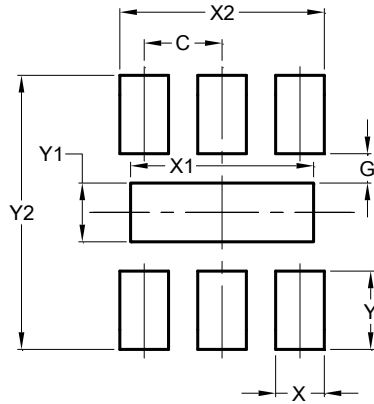


X2-DFN1212-6			
Dim	Min	Max	Typ
A	-	0.40	0.39
A1	0.00	0.05	0.020
A3	-	-	0.13
b	0.13	0.23	0.18
D	1.15	1.25	1.20
D2	0.89	0.99	0.94
E	1.15	1.25	1.20
E2	0.25	0.35	0.30
e	-	-	0.40
k	0.15	0.25	0.20
L	0.15	0.25	0.20
z	-	-	0.11
z1	-	-	0.05
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

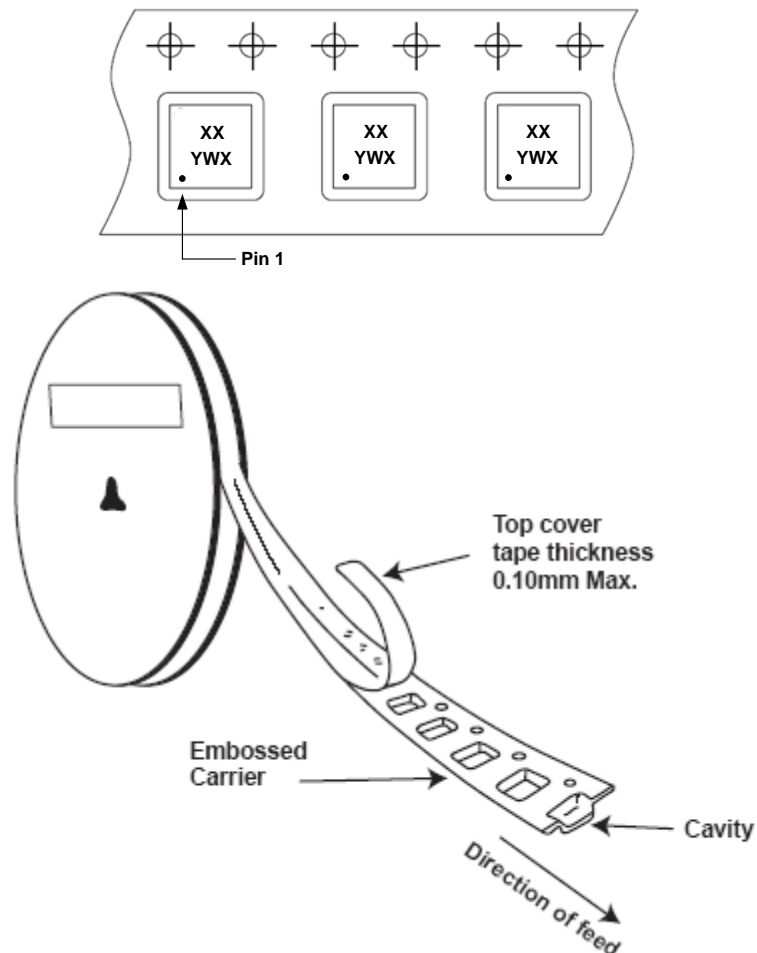
(1) Package Type: X2-DFN1212-6



Dimensions	Value (in mm)
C	0.400
G	0.150
X	0.250
X1	0.940
X2	1.050
Y	0.400
Y1	0.300
Y2	1.400

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## Tape Orientation



Note: The taping orientation of the other package type can be found on our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

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2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

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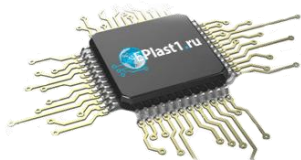
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.